

*#8/Response*  
*2/6/03*  
*(NE)*RESPONSE UNDER 37 C.F.R.  
§1.116 EXPEDITED PROCEDURE  
EXAMINING GROUP 2823**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Stephen L. Buchwalter, et al.

Examiner: Khiem D. Nguyen

Serial No: 09/782,494

Art Unit: 2823

Filed: February 13, 2001

Docket: YOR920000745US1 (14029)

For: BILAYER WAFER-LEVEL UNDERFILL

Dated: February 4, 2003

Assistant Commissioner for Patents  
United States Patent and Trademark Office  
Washington, D.C. 20231

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**RESPONSE UNDER 37 C.F.R. §1.116**

FEB 04 2003

Sir:

TECHNOLOGY CENTER 2800

In response to the Office Action dated December 4, 2002, applicants submit the following remarks for consideration by the Examiner and entry of record in the above-identified patent application.

**REMARKS**

Favorable reconsideration of this application in view of the remarks to follow is respectfully requested. Since the present Response raises no new issues, and in any event, places the application in better condition for consideration on appeal, entry thereof is respectfully requested under the provisions of 37 C.F.R. §1.116.

**CERTIFICATION OF FACSIMILE TRANSMISSION**

I hereby certify that this paper is being facsimile transmitted to the Patent and Trademark Office on the date shown below.

Dated: February 4, 2003

*Grace Colucci*  
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